Docket No.: 2336-256 PATENT

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of	:	
Ju Hyun KIM et al.	:	Confirmation No
U.S. Patent Application No	:	Group Art Unit:
Filed: March 29, 2004	:	Examiner:

For: METHOD FOR SEPARATING SAPPHIRE WAFER INTO CHIPS USING DRY-

**ETCHING** 

## **INFORMATION DISCLOSURE STATEMENT**

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

In accordance with the provisions of 37 C.F.R. 1.56, 1.97 and 1.98, the attention of the Patent and Trademark Office is hereby directed to the documents listed on the attached form PTO-1449. It is respectfully requested that the documents be expressly considered during the prosecution of this application, and that the documents be made of record therein and appear among the "References Cited" on any patent to issue therefrom.

This Information Disclosure Statement is being filed within three months of the U.S. filing date OR before the mailing date of a first Office Action on the merits. No certification or fee is required.

Respectfully submitted,

LOWE AJAUPTMAN GILMAN & BERNER, LLP

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INFORMATION DISCLOSURE CITATION IN AN APPLICATION (PTO-1449)		ATTY. DOCKET NO. 2336-256		U.S. PATENT APPLICATION NO.		
		APPLICANT Ju Hyun KIM et al.				
		FILING DATE March 29, 2004		GROUP		
			DOCUMENTS			
EXAMINER'S INITIALS	PATENT NO.	DATE	NAME	CLASS	SUBCLASS	FILING DATE
	6465158 10/2002		Sekiya			
	6593170					
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<u>,</u>		FOREIGN PATE	NT DOCUMENTS			
EXAMINER'S INITIALS	PATENT NO.	DATE	COUNTRY		SUBCLASS	Translation Yes No
	OTHE	R ART (Including Author	, Title, Date, Pertine	ent Pages, Et	c.)	
EXAMINER			DATE CONSIDER	ED	···	
LAMININEK	DATE CONSIDERED					

EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; draw line through citation if not in conformance and not considered. Include copy of this form with next communication to Applicant.